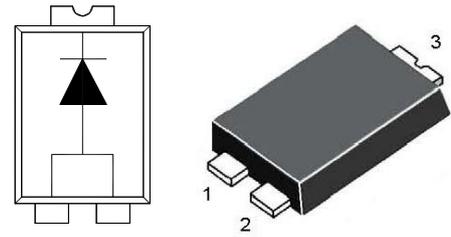


# SDB0540

## Surface Mount Schottky Barrier Rectifier

### Features

- Low forward voltage drop



TO-277 Plastic Package

### Absolute Maximum Ratings ( $T_a = 25^\circ\text{C}$ )

Parameter	Symbol	Value	Unit
Working Peak Reverse Voltage	$V_{RWM}$	40	V
Repetitive Peak Reverse Voltage	$V_{RRM}$	40	V
Reverse Voltage	$V_R$	40	V
RMS Reverse Voltage	$V_{R(RMS)}$	28	V
Average Rectified Output Current	$I_O$	5	A
Non-Repetitive Peak Forward Surge Current ( $t = 8.3$ ms)	$I_{FSM}$	120	A
Typical Thermal Resistance, Junction to Ambient <sup>1)</sup>	$R_{\theta JA}$	95	$^\circ\text{C/W}$
Typical Thermal Resistance, Junction to Ambient <sup>2)</sup>	$R_{\theta JA}$	70	$^\circ\text{C/W}$
Typical Thermal Resistance, Junction to Ambient <sup>3)</sup>	$R_{\theta JA}$	50	$^\circ\text{C/W}$
Operating and Storage Temperature Range	$T_J$ $T_{stg}$	- 55 to + 150	$^\circ\text{C}$

<sup>1)</sup> FR-4 PCB, 2oz. Copper, minimum recommended pad layout.

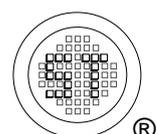
<sup>2)</sup> Polyimide PCB, 2oz. Copper, minimum recommended pad layout.

<sup>3)</sup> Polyimide PCB, 2oz. Copper, cathode pad dimensions 9.4 mm x 7.2 mm, Anode pad dimensions 2.7 mm x 1.6 mm.

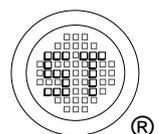
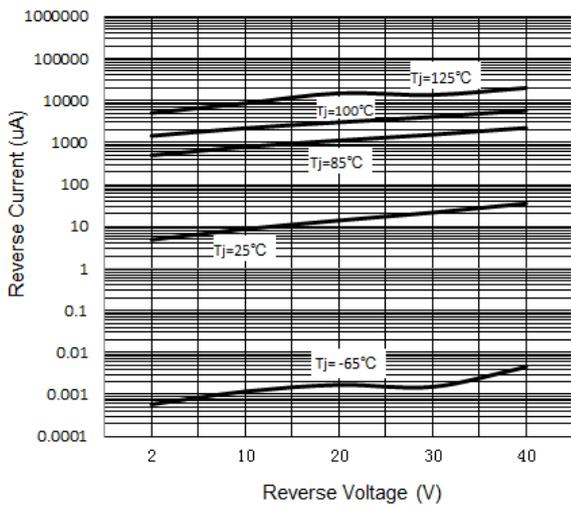
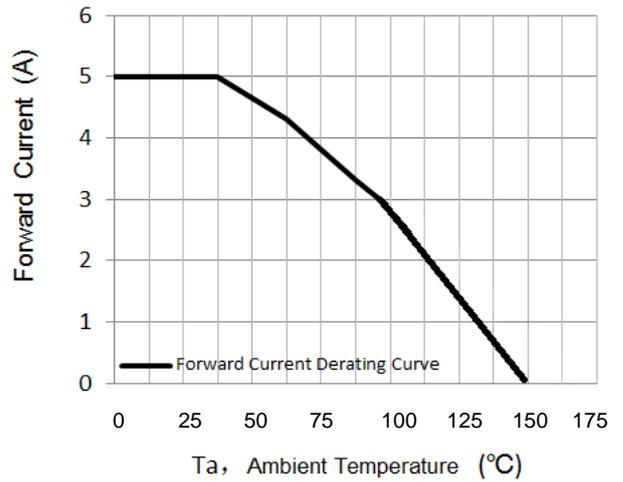
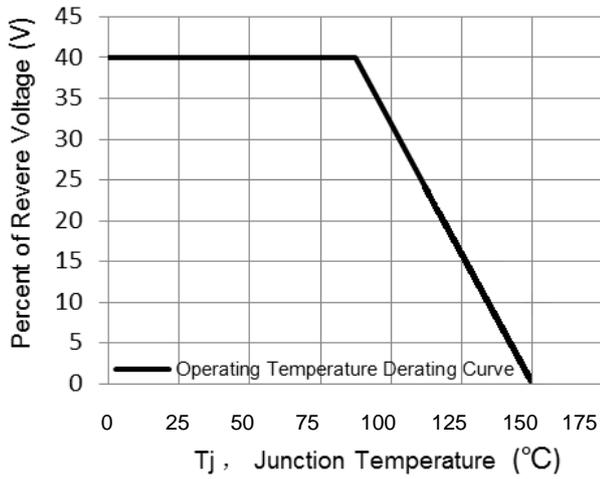
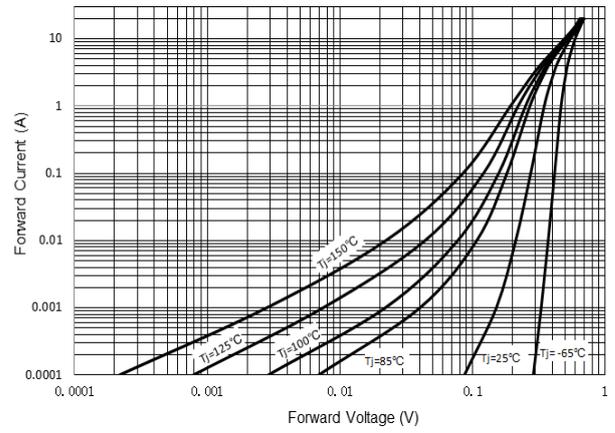
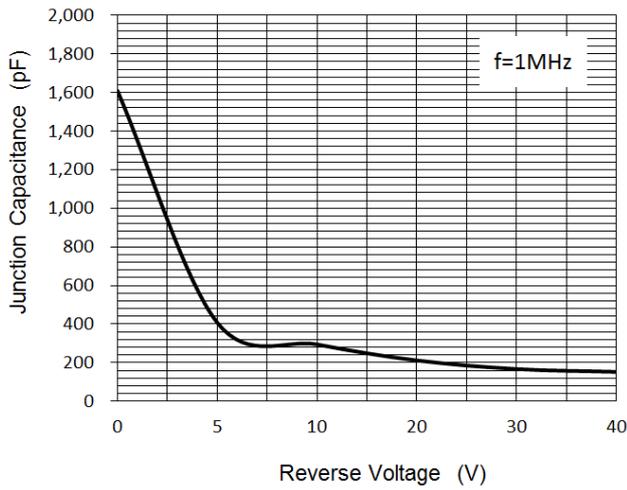
### Characteristics at $T_a = 25^\circ\text{C}$

Parameter	Symbol	Min.	Typ.	Max.	Unit
Reverse Breakdown Voltage at $I_R = 0.5$ mA	$V_{BR}$	40	-	-	V
Forward Voltage at $I_F = 5$ A, $T_J = 25^\circ\text{C}$ at $I_F = 5$ A, $T_J = 125^\circ\text{C}$ at $I_F = 10$ A, $T_J = 25^\circ\text{C}$ at $I_F = 10$ A, $T_J = 125^\circ\text{C}$	$V_F$	- - - -	- - - -	0.52 0.47 0.65 0.59	V
Reverse Current <sup>1)</sup> at $V_R = 40$ V, $T_J = 25^\circ\text{C}$ at $V_R = 40$ V, $T_J = 100^\circ\text{C}$ at $V_R = 40$ V, $T_J = 125^\circ\text{C}$	$I_R$	- - -	- - -	0.3 20 40	mA
Junction Capacitance at $V_R = 0$ V, $f = 1$ MHz	$C_J$	-	1600	-	pF

<sup>1)</sup> Short duration pulse test used to minimize self-heating effect.



# SDB0540

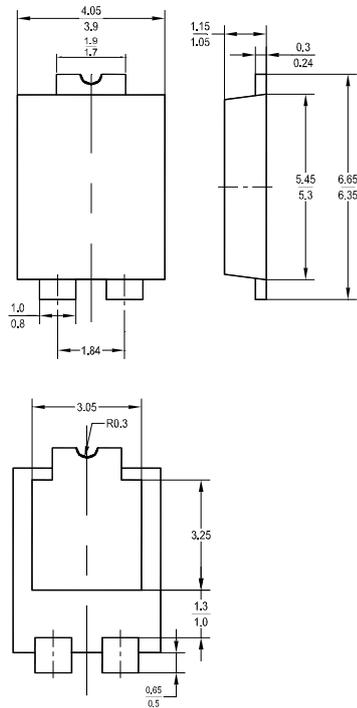


# SDB0540

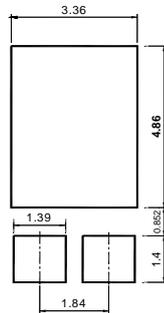
## PACKAGE OUTLINE

Plastic surface mounted package (Units: mm)

TO-277



## Recommended Soldering Footprint



## Packing information

Package	Tape Width (mm)	Pitch		Reel Size		Per Reel Packing Quantity
		mm	inch	mm	inch	
TO-277	12	8 ± 0.1	0.315 ± 0.004	330	13	5,000

## Marking information

" SDB0540 " = Part No.

" YYWW " = Date Code Marking

" Y " = Year (ex: 19 = 2019)

" W " = Week (ex: 09 = the 9th week of the year)

Font type: Arial

